



Accurate Kinetic Energy
No.11-3 Jianguo Rd., Tanzi Dist., 42760 Taiwan

All dimensions are millimeters.

CAD:	TCR
Review:	EG
Appr:	JL
Page:	1/4
Date:	August 01,2022

Specification Title:

**HCMOS Output Clock Oscillator
Miniature
3.2 x 2.5 millimeter Surface Mount
General Product Specification**

Part Number:

S3 Series

Electrical Specifications:

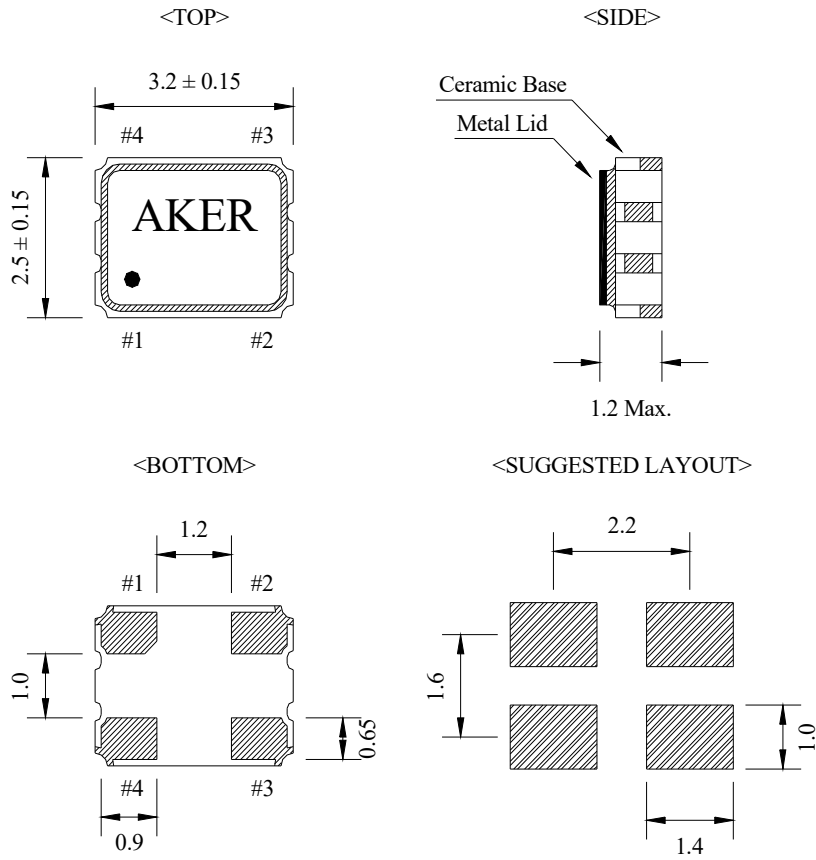
Frequency Range	1.000~54.000	1.000~75.000	1.000~156.250	1.000~54.000	1.000~54.000	MHz	
Frequency Stability	±20 ~ ±100					ppm	
Aging per Year	±3					ppm Max.	
Operating Temperature Range	Standard	-20 ~ +70				°C	
	Extended	-40 ~ +85 Or Specify (-40~+125 is available)					
Storage Temperature Range	-55 ~ +125						
Supply Voltage	1.8 ± 5%	2.5 ± 5%	3.3 ± 10%	1.62 ~ 3.63	5.0 ± 10%	VDD	
Input Current	1.000 to 9.999MHz	5	6	7	7	10	mA Max.
	10.000 to 19.999MHz	6	7	7	7	12	
	20.000 to 31.999MHz	6	8	12	12	15	
	32.000 to 54.000MHz	15	20	20	20	22	
	54.001 to 79.999MHz	-	25	25	-	-	
	80.000 to 156.250MHz	-	-	30	-	-	
Output Voltage	Logic High (Voh)	90%				VDD Min.	
	Logic Low (Vol)	10%				VDD Max.	
Output Symmetry (Duty Cycle)	Standard	40 ~ 60 (at 50% VDD)				%	
	Tight	45 ~ 55 (at 50% VDD)					
Output Level	CMOS						
Output Load	15					pF Max.	
Rise and Fall Time	1.000 to 9.999MHz	7	5	5	7	5	ns Max.
	10.000 to 19.999MHz	7	5	5	7	5	
	20.000 to 31.999MHz	6	5	5	6	4	
	32.000 to 54.000MHz	6	5	5	6	4	
	54.001 to 79.999MHz	-	6	5	-	-	
	80.000 to 156.250MHz	-	-	5	-	-	
Phase Jitter (12 KHz to 20 MHz)	1					ps Max. RMS	
Enable-Disable Function	Tri-State						
Start Up Time	10					ms Max.	

Temperature stability is Inclusive of all conditions:

Calibration Tolerance at +25°C, frequency stability over the operating temperature range, supply voltage change, output load change, shock, vibration, and 1st year aging at +25°C.

RoHS Compliant Pb - Lead Free	Ltr	Revisions	Date	Appr

Mechanical Outline and Solder Pad Layout:



Pin Connection	
PIN No.	Connection
#1	Enable/Disable
#2	GND
#3	Output
#4	VDD

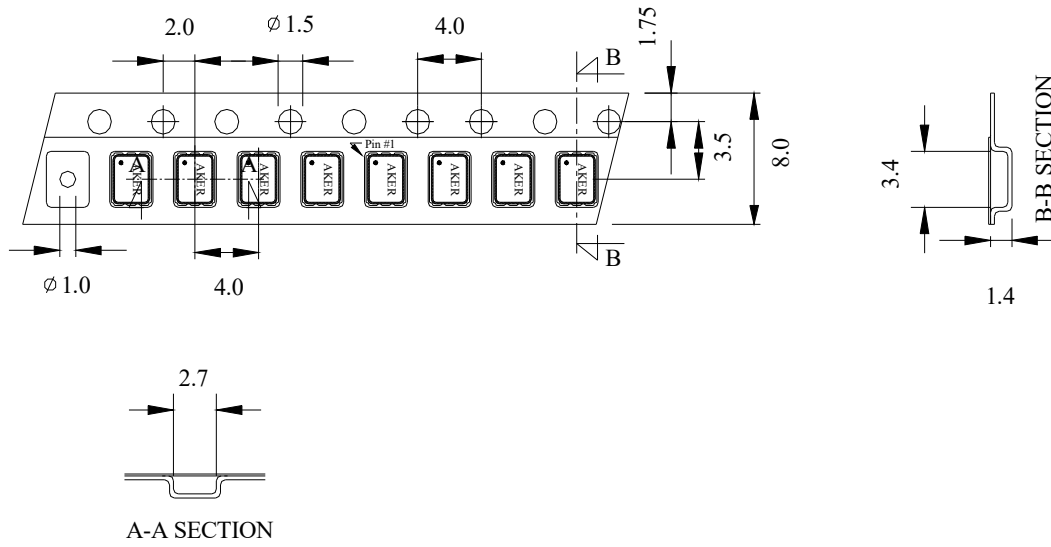
Enable/Disable Function	
PIN #1	PIN #3
HIGH or OPEN	Operating
LOW	High Impedance

Package is Seam Sealed Ceramic-Metal.

Terminator Pads are Ni/Au.

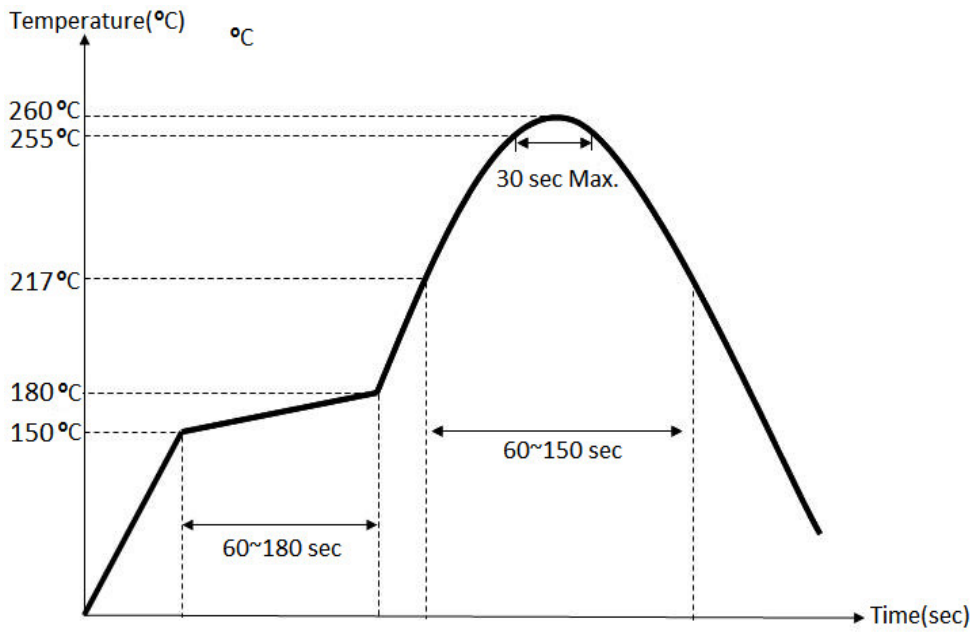
Dimensions are millimeters.

Carrier Tape Dimensions:



Dimensions are millimeters.

Solder Reflow Characteristics:



How to build a Part Number:

Series	S	Parameter
Package	3	3.2 x 2.5 mm
Supply Voltage	50	+5.0 VDD ± 10%
	33	+3.3 VDD ± 10%
	25	+2.5 VDD ± 5%
	18	+1.8 VDD ± 5%
	M	+1.62 ~ +3.63 VDD
Temperature Stability	10	±100 ppm
	05	±50 ppm
	03	±30 ppm
	025	±25 ppm
Duty Cycle	See Notes	40%~60%
	T	45%~55%
Frequency	1.000~156.250	MHz
Temperature Range	See Notes	-20 ~ +70 °C
	X	-40 ~ +85 °C
	X1	-40 ~ +125 °C
	X2	-40 ~ +105 °C
Packaging	M	250pcs Reel
	R	1000pcs Reel
	R3	3000pcs Reel

Part Number Example:

S33305T-50.000-X-R

S3: 3.2 x 2.5 mm SMD Package

33: +3.3±10% VDD Supply Voltage

05: ±50 ppm Temperature Stability

T: 45%~55% Tight Symmetry

50.000 MHz Nominal Frequency

X: -40 ~ + 85°C Extended Temperature Range

R: Tape and Reel Packaging - 1000pcs Reel

Notes:

- 1- Standard Duty Cycle and Temperature Range do not need to be included in Part Number description.
- 2- Product is shipped in Tape and Reel configuration.
- 3- Quantities less than 250pcs are shipped in tape only.
- 4- Specification subject to change without notice.